S1C33210



Mobile Access Gateway IC

- 32-bit RISC CPU
- HDLC controller
- Three serial I/O (SIO) interfaces
- PDC, PHS, and CdmaOne interfaces*1
- Multiply-and-accumulate instructions
- 8 Kbytes of built-in RAM
- Built-in analog-to-digital converter
- High-speed DMA and intelligent DMA
- Low power consumption

*1: These interfaces require the software modem module.

DESCRIPTIONS

The SIC33210 single-chip microcomputer consists of the S1C33000 CMOS 32-bit RISC CPU core plus an HDLC controller, three serial I/O (SIO) interfaces, 8 Kbytes of built-in RAM, a direct memory access (DMA) controller, timers, an analog to-digital converter, and other components. The device features both high-speed operation and low power consumption. The HDLC controller, serial I/O (SIO) interfaces, and other components necessary for mobile access make this device ideal for data communications adapters, PDAs, and other portable information equipment. The multiply-and-accumulate instructions and analog-to-digital converter support voice recognition, voice synthesis, and other forms of digital signal processing for use in portable multimedia terminals.

■ FEATURES

● CMOS LSI 32-bit parallel processing S1C33000 RISC core

● Main clock 50 MHz (Max., with built-in 4× phase-locked loop)

● Sub clock 32.768kHz (Typ., crystal)

● Instruction set 16-bit fixed length, 105 instructions

(MAC instruction is included, 2 cycles)

● Internal RAM size 8,192 bytes
■ Clock timer 1 channel

◆ Programmable timer
 ◆ PWM timer
 ◆ Watchdog timer
 B bits × 6 channels and 16 bits × 6 channels
 ◆ Application for 16-bit programmable timer
 ◆ Realized with a 16-bit programmable timer

●PDC interface 1 channel

Control interface represents application for serial I/O (SIO) interface

● PHS interface 1 channel

Control interface represents application for serial I/O (SIO) interface. Supports both 32 and 64 kbps. Built-in I.460 speed conversion.

HDLC controllerSerial interface1 channel3 channels

Clock synchronization type and asynchronization type are selectable.

Usable as an infrared ray (IrDA) interface.

● 10-bit A/D converter Successive approximation type, 8 input channels

High-speed DMAIntelligent DMA4 channels128 channels

●I/O port Input port: 7 bits, I/O port: 27 bits

These pins double as I/O pins for the onboard peripherals.

● Interrupt controller External interrupts : 10 types Internal interrupts: 29 types

External bus interface 24-bit address bus, 16-bit data bus, 7 chip enable pins

DRAM and burst ROM may be connected directly.

● Shipping form QFP15-128pin

● Supply voltage Internal operating voltage: 2.7 to 3.6 V

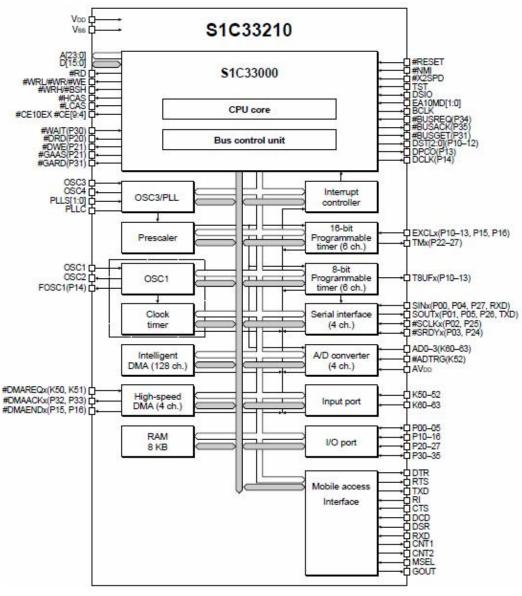
I/O levels: 2.7 to 3.6 V

■ Current consumption In SLEEP mode: 4 µW Typ.

During normal operation: 230 mW Typ. at 3.3 V, 50 MHz

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■ Block Diagram



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